Dual buffer/line driver; 3-state

Rev. 1 — 11 March 2014

**Product data sheet** 

### 1. General description

The 74AHC2G126-Q100 and 74AHCT2G126-Q100 are high-speed Si-gate CMOS devices. They provide a dual non-inverting buffer/line driver with 3-state output. The 3-state output is controlled by the output enable input (nOE). A LOW at nOE causes the output to assume a high-impedance OFF-state.

The AHC device has CMOS input switching levels and supply voltage range 2 V to 5.5 V.

The AHCT device has TTL input switching levels and supply voltage range 4.5 V to 5.5 V.

This product has been qualified to the Automotive Electronics Council (AEC) standard Q100 (Grade 1) and is suitable for use in automotive applications.

### 2. Features and benefits

- Automotive product qualification in accordance with AEC-Q100 (Grade 1)
  - ◆ Specified from -40 °C to +85 °C and from -40 °C to +125 °C
- Symmetrical output impedance
- High noise immunity
- Low power dissipation
- Balanced propagation delays
- Multiple package options
- ESD protection:
  - MIL-STD-883, method 3015 exceeds 2000 V
  - HBM JESD22-A114F exceeds 2000 V
  - MM JESD22-A115-A exceeds 200 V (C = 200 pf, R = 0 Ω)



Dual buffer/line driver; 3-state

## 3. Ordering information

| Table 1.         Ordering information |                   |        |   |          |  |  |  |  |  |  |  |
|---------------------------------------|-------------------|--------|---|----------|--|--|--|--|--|--|--|
| Type number                           | Package           |        |   |          |  |  |  |  |  |  |  |
|                                       | Temperature range | Name   | Description   | Version  |  |  |  |  |  |  |  |
| 74AHC2G126DP-Q100                     | –40 °C to +125 °C | TSSOP8 | plastic thin shrink small outline package; 8 leads; | SOT505-2 |  |  |  |  |  |  |  |
| 74AHCT2G126DP-Q100                    |                   |        | body width 3 mm; lead length 0.5 mm                 |          |  |  |  |  |  |  |  |
| 74AHC2G126DC-Q100                     | –40 °C to +125 °C | VSSOP8 | plastic very thin shrink small outline package;     | SOT765-1 |  |  |  |  |  |  |  |
| 74AHCT2G126DC-Q100                    |                   |        | 8 leads; body width 2.3 mm                          |          |  |  |  |  |  |  |  |

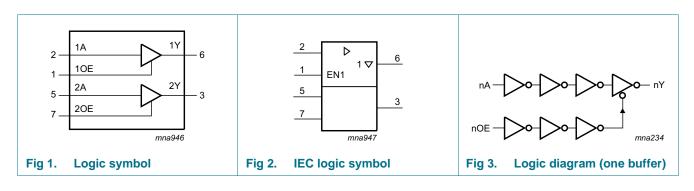
### 4. Marking

#### Table 2. Marking codes

| Type number        | Marking <sup>[1]</sup> |
|--------------------|------------------------|
| 74AHC2G126DP-Q100  | A26                    |
| 74AHCT2G126DP-Q100 | C26                    |
| 74AHC2G126DC-Q100  | A26                    |
| 74AHCT2G126DC-Q100 | C26                    |

[1] The pin 1 indicator is located on the lower left corner of the device, below the marking code.

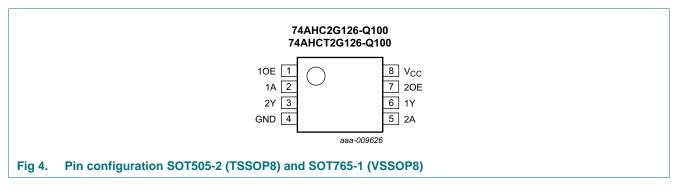
## 5. Functional diagram



Dual buffer/line driver; 3-state

### 6. Pinning information

### 6.1 Pinning



### 6.2 Pin description

| Table 3.     Pin description |      |                                   |  |  |  |  |  |  |  |  |
|------------------------------|------|-----------------------------------|--|--|--|--|--|--|--|--|
| Symbol                       | Pin  | Description                       |  |  |  |  |  |  |  |  |
| 10E, 20E                     | 1, 7 | output enable input (active HIGH) |  |  |  |  |  |  |  |  |
| 1A, 2A                       | 2, 5 | data input                        |  |  |  |  |  |  |  |  |
| GND                          | 4    | ground (0 V)                      |  |  |  |  |  |  |  |  |
| 1Y, 2Y                       | 6, 3 | data output                       |  |  |  |  |  |  |  |  |
| V <sub>CC</sub>              | 8    | supply voltage                    |  |  |  |  |  |  |  |  |

### 7. Functional description

#### Table 4. Function table<sup>[1]</sup>

|     | Input | Output |
|-----|-------|--------|
| nOE | nA    | nY     |
| Н   | L     | L      |
| Н   | Н     | Н      |
| L   | X     | Z      |

[1] H = HIGH voltage level; L = LOW voltage level; X = don't care; Z = high-impedance OFF-state.

## 8. Limiting values

#### Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

| Symbol           | Parameter               | Conditions  |            | Min  | Max  | Unit |
|------------------|-------------------------|---|------------|------|------|------|
| V <sub>CC</sub>  | supply voltage          |   |            | -0.5 | +7.0 | V    |
| VI               | input voltage           |   |            | -0.5 | +7.0 | V    |
| I <sub>IK</sub>  | input clamping current  | V <sub>I</sub> < -0.5 V   | <u>[1]</u> | -20  | -    | mA   |
| I <sub>OK</sub>  | output clamping current | $V_{\rm O}$ < –0.5 V or $V_{\rm O}$ > $V_{\rm CC}$ + 0.5 V                    | <u>[1]</u> | -    | ±20  | mA   |
| I <sub>O</sub>   | output current          | $-0.5 \text{ V} < \text{V}_{\text{O}} < \text{V}_{\text{CC}} + 0.5 \text{ V}$ |            | -    | ±25  | mA   |
| I <sub>CC</sub>  | supply current          |   |            | -    | 75   | mA   |
| I <sub>GND</sub> | ground current          |   |            | -75  | -    | mA   |
| T <sub>stg</sub> | storage temperature     |   |            | -65  | +150 | °C   |
| P <sub>tot</sub> | total power dissipation | $T_{amb} = -40 \ ^{\circ}C \ to +125 \ ^{\circ}C$                             | [2]        | -    | 250  | mW   |

[1] The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

[2] For TSSOP8 package: above 55 °C the value of P<sub>tot</sub> derates linearly with 2.5 mW/K. For VSSOP8 package: above 110 °C the value of P<sub>tot</sub> derates linearly with 8 mW/K.

### 9. Recommended operating conditions

#### Table 6. Recommended operating conditions

Voltages are referenced to GND (ground = 0 V).

| Symbol           | Parameter             | Conditions                   | 74AH | C2G126 | -Q100           | 74AHCT2G126-Q100 |     |                 | Unit |
|------------------|-----------------------|------------------------------|------|--------|-----------------|------------------|-----|-----------------|------|
|                  |                       |                              | Min  | Тур    | Max             | Min              | Тур | Max             |      |
| V <sub>CC</sub>  | supply voltage        |                              | 2.0  | 5.0    | 5.5             | 4.5              | 5.0 | 5.5             | V    |
| VI               | input voltage         |                              | 0    | -      | 5.5             | 0                | -   | 5.5             | V    |
| Vo               | output voltage        |                              | 0    | -      | V <sub>CC</sub> | 0                | -   | V <sub>CC</sub> | V    |
| T <sub>amb</sub> | ambient temperature   |                              | -40  | +25    | +125            | -40              | +25 | +125            | °C   |
| Δt/ΔV            | input transition rise | $V_{CC}$ = 3.3 V $\pm$ 0.3 V | -    | -      | 100             | -                | -   | -               | ns/V |
|                  | and fall rate         | $V_{CC}$ = 5.0 V $\pm$ 0.5 V | -    | -      | 20              | -                | -   | 20              | ns/V |

Dual buffer/line driver; 3-state

## **10. Static characteristics**

#### Table 7.Static characteristics

Voltages are referenced to GND (ground = 0 V).

| Symbol          | Parameter                   | Conditions   |      | 25 °C |      | –40 °C | to +85 °C | <b>−40 °C</b> | to +125 °C | Unit |
|-----------------|-----------------------------|--|------|-------|------|--------|-----------|---------------|------------|------|
|                 |                             |  | Min  | Тур   | Max  | Min    | Max       | Min           | Max        |      |
| 74AHC2          | G126-Q100                   | 1  |      |       |      |        |           |               |            |      |
| VIH             | HIGH-level                  | V <sub>CC</sub> = 2.0 V  | 1.5  | -     | -    | 1.5    | -         | 1.5           | -          | V    |
|                 | input voltage               | V <sub>CC</sub> = 3.0 V  | 2.1  | -     | -    | 2.1    | -         | 2.1           | -          | V    |
|                 |                             | V <sub>CC</sub> = 5.5 V  | 3.85 | -     | -    | 3.85   | -         | 3.85          | -          | V    |
| V <sub>IL</sub> | LOW-level                   | V <sub>CC</sub> = 2.0 V  | -    | -     | 0.5  | -      | 0.5       | -             | 0.5        | V    |
|                 | input voltage               | V <sub>CC</sub> = 3.0 V  | -    | -     | 0.9  | -      | 0.9       | -             | 0.9        | V    |
|                 |                             | V <sub>CC</sub> = 5.5 V  | -    | -     | 1.65 | -      | 1.65      | -             | 1.65       | V    |
| V <sub>OH</sub> | HIGH-level                  | $V_{I} = V_{IH} \text{ or } V_{IL}$                              |      |       |      |        |           |               |            |      |
|                 | output voltage              | $I_{O} = -50 \ \mu\text{A}; \ V_{CC} = 2.0 \ \text{V}$           | 1.9  | 2.0   | -    | 1.9    | -         | 1.9           | -          | V    |
|                 |                             | $I_{O} = -50 \ \mu\text{A}; \ V_{CC} = 3.0 \ \text{V}$           | 2.9  | 3.0   | -    | 2.9    | -         | 2.9           | -          | V    |
|                 |                             | $I_{O} = -50 \ \mu\text{A}; \ V_{CC} = 4.5 \ \text{V}$           | 4.4  | 4.5   | -    | 4.4    | -         | 4.4           | -          | V    |
|                 |                             | $I_{O} = -4.0 \text{ mA}; V_{CC} = 3.0 \text{ V}$                | 2.58 | -     | -    | 2.48   | -         | 2.40          | -          | V    |
|                 |                             | $I_{O} = -8.0 \text{ mA}; V_{CC} = 4.5 \text{ V}$                | 3.94 | -     | -    | 3.8    | -         | 3.70          | -          | V    |
| V <sub>OL</sub> | LOW-level                   | $V_{I} = V_{IH} \text{ or } V_{IL}$                              |      |       |      |        |           |               |            |      |
|                 | output voltage              | $I_0 = 50 \ \mu A; \ V_{CC} = 2.0 \ V$                           | -    | 0     | 0.1  | -      | 0.1       | -             | 0.1        | V    |
|                 |                             | $I_0 = 50 \ \mu A; \ V_{CC} = 3.0 \ V$                           | -    | 0     | 0.1  | -      | 0.1       | -             | 0.1        | V    |
|                 |                             | $I_0 = 50 \ \mu A; V_{CC} = 4.5 \ V$                             | -    | 0     | 0.1  | -      | 0.1       | -             | 0.1        | V    |
|                 |                             | $I_{O}$ = 4.0 mA; $V_{CC}$ = 3.0 V                               | -    | -     | 0.36 | -      | 0.44      | -             | 0.55       | V    |
|                 |                             | $I_{O}$ = 8.0 mA; $V_{CC}$ = 4.5 V                               | -    | -     | 0.36 | -      | 0.44      | -             | 0.55       | V    |
| I <sub>OZ</sub> | OFF-state<br>output current | $V_I = V_{CC} \text{ or GND};$<br>$V_{CC} = 5.5 \text{ V}$       | -    | -     | 0.25 | -      | 2.5       | -             | 10         | μA   |
| I <sub>I</sub>  | input leakage<br>current    | V <sub>I</sub> = 5.5 V or GND;<br>V <sub>CC</sub> = 0 V to 5.5 V | -    | -     | 0.1  | -      | 1.0       | -             | 2.0        | μΑ   |
| I <sub>CC</sub> | supply current              | $V_I = V_{CC}$ or GND; $I_O = 0$ A;<br>$V_{CC} = 5.5$ V          | -    | -     | 1.0  | -      | 10        | -             | 40         | μΑ   |
| CI              | input<br>capacitance        |  | -    | 1.5   | 10   | -      | 10        | -             | 10         | pF   |
| 74AHCT          | 2G126-Q100                  |  |      |       |      |        |           |               |            |      |
| V <sub>IH</sub> | HIGH-level input voltage    | $V_{CC}$ = 4.5 V to 5.5 V  | 2.0  | -     | -    | 2.0    | -         | 2.0           | -          | V    |
| V <sub>IL</sub> | LOW-level                   | $V_{CC}$ = 4.5 V to 5.5 V  | -    | -     | 0.8  | -      | 0.8       | -             | 0.8        | V    |
| V <sub>OH</sub> | HIGH-level                  | $V_{I} = V_{IH} \text{ or } V_{IL}; V_{CC} = 4.5 \text{ V}$      |      |       |      |        |           |               |            |      |
|                 | output voltage              | $I_{O} = -50 \ \mu A$  | 4.4  | 4.5   | -    | 4.4    | -         | 4.4           | -          | V    |
|                 |                             | $I_0 = -8.0 \text{ mA}$  | 3.94 | -     | -    | 3.8    | -         | 3.70          | -          | V    |
| V <sub>OL</sub> | LOW-level                   | $V_{I} = V_{IH} \text{ or } V_{IL}; V_{CC} = 4.5 \text{ V}$      |      |       |      |        |           |               |            | +    |
|                 | output voltage              | $I_0 = 50 \mu\text{A}$   | -    | 0     | 0.1  | -      | 0.1       | -             | 0.1        | V    |
|                 |                             | $I_{0} = 8.0 \text{ mA}$   | -    | -     | 0.36 | -      | 0.44      | -             | 0.55       | V    |

74AHC\_AHCT2G126\_Q100

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Dual buffer/line driver; 3-state

| Symbol           | Parameter                   | Conditions   | 25 °C |     |      | –40 °C to +85 °C |     | –40 °C to +125 °C |     | Unit |
|------------------|-----------------------------|--|-------|-----|------|------------------|-----|-------------------|-----|------|
|                  |                             |  | Min   | Тур | Max  | Min              | Max | Min               | Max |      |
| I <sub>OZ</sub>  | OFF-state<br>output current | $V_I = V_{CC} \text{ or GND};$<br>$V_{CC} = 5.5 \text{ V}$   | -     | -   | 0.25 | -                | 2.5 | -                 | 10  | μΑ   |
| I <sub>I</sub>   | input leakage<br>current    | V <sub>I</sub> = 5.5 V or GND;<br>V <sub>CC</sub> = 0 V to 5.5 V                                     | -     | -   | 0.1  | -                | 1.0 | -                 | 2.0 | μA   |
| I <sub>CC</sub>  | supply current              |  | -     | -   | 1.0  | -                | 10  | -                 | 40  | μA   |
| ∆l <sub>CC</sub> | additional supply current   | per input pin; $V_I = 3.4 V$ ;<br>other inputs at $V_{CC}$ or GND;<br>$I_O = 0 A$ ; $V_{CC} = 5.5 V$ | -     | -   | 1.35 | -                | 1.5 | -                 | 1.5 | mA   |
| CI               | input<br>capacitance        |  | -     | 1.5 | 10   | -                | 10  | -                 | 10  | pF   |

 Table 7.
 Static characteristics ... continued

 Voltages are referenced to GND (ground = 0 V).

### **11. Dynamic characteristics**

### Table 8.Dynamic characteristics

GND = 0 V; for test circuit see <u>Figure 7</u>.

| Symbol           | Parameter  | Conditions   |            |     | 25 °C |      | –40 °C | to +85 °C | –40 °C t | o +125 °C | Unit |
|------------------|--|--|------------|-----|-------|------|--------|-----------|----------|-----------|------|
|                  |  |  |            | Min | Тур   | Max  | Min    | Max       | Min      | Max       |      |
| 74AHC2           | G126-Q100  |  |            |     |       |      | _      |           | -        |           | -    |
| t <sub>pd</sub>  | propagation  | nA to nY; see Figure 5                             | [1]        |     |       |      |        |           |          |           |      |
|                  | delay  | $V_{CC} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$ | [2]        |     |       |      |        |           |          |           |      |
|                  |  | C <sub>L</sub> = 15 pF                             |            | -   | 4.7   | 8.0  | 1.0    | 9.5       | 1.0      | 11.5      | ns   |
|                  |  | C <sub>L</sub> = 50 pF                             |            | -   | 6.6   | 11.5 | 1.0    | 13.0      | 1.0      | 14.5      | ns   |
|                  |  | $V_{CC}$ = 4.5 V to 5.5 V                          | <u>[3]</u> |     |       |      |        |           |          | 1         | -    |
|                  |  | C <sub>L</sub> = 15 pF                             |            | -   | 3.4   | 5.5  | 1.0    | 6.5       | 1.0      | 7.0       | ns   |
|                  |  | C <sub>L</sub> = 50 pF                             |            | -   | 4.8   | 7.5  | 1.0    | 8.5       | 1.0      | 9.5       | ns   |
| t <sub>en</sub>  | enable time  | nOE to nY; see Figure 6                            | <u>[1]</u> |     |       |      |        |           |          | 1         | _    |
|                  | $V_{CC} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$ | [2]  |            |     |       |      |        |           |          |           |      |
|                  |  | C <sub>L</sub> = 15 pF                             |            | -   | 5.0   | 8.0  | 1.0    | 9.5       | 1.0      | 11.5      | ns   |
|                  |  | C <sub>L</sub> = 50 pF                             |            | -   | 6.9   | 11.5 | 1.0    | 13.0      | 1.0      | 14.5      | ns   |
|                  |  | $V_{CC}$ = 4.5 V to 5.5 V                          | <u>[3]</u> |     |       |      |        |           |          |           |      |
|                  |  | C <sub>L</sub> = 15 pF                             |            | -   | 3.6   | 5.1  | 1.0    | 6.0       | 1.0      | 6.5       | ns   |
|                  |  | C <sub>L</sub> = 50 pF                             |            | -   | 4.9   | 7.5  | 1.0    | 9.0       | 1.0      | 9.5       | ns   |
| t <sub>dis</sub> | disable time                                       | nOE to nY; see Figure 6                            | <u>[1]</u> |     |       |      |        |           |          |           |      |
|                  |  | $V_{CC} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$ | [2]        |     |       |      |        |           |          |           |      |
|                  |  | C <sub>L</sub> = 15 pF                             |            | -   | 6.0   | 9.7  | 1.0    | 11.5      | 1.0      | 12.5      | ns   |
|                  |  | C <sub>L</sub> = 50 pF                             |            | -   | 8.3   | 13.2 | 1.0    | 15.0      | 1.0      | 16.5      | ns   |
|                  |  | $V_{CC}$ = 4.5 V to 5.5 V                          | [3]        |     | •     |      |        |           |          |           | -    |
|                  |  | C <sub>L</sub> = 15 pF                             |            | -   | 4.1   | 6.8  | 1.0    | 8.0       | 1.0      | 8.5       | ns   |
|                  |  | C <sub>L</sub> = 50 pF                             |            | -   | 5.7   | 8.8  | 1.0    | 10.0      | 1.0      | 11.0      | ns   |

74AHC\_AHCT2G126\_Q100

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Dual buffer/line driver; 3-state

| Symbol                      | Parameter                           | Conditions   |            |     | 25 °C |     | –40 °C | to +85 °C | –40 °C t | o +125 °C | Unit |
|-----------------------------|-------------------------------------|--|------------|-----|-------|-----|--------|-----------|----------|-----------|------|
|                             |                                     |  |            | Min | Тур   | Max | Min    | Max       | Min      | Max       |      |
| C <sub>PD</sub>             | power<br>dissipation<br>capacitance | per buffer;<br>$C_L = 50 \text{ pF}; f_i = 1 \text{ MHz};$<br>$V_I = \text{GND to } V_{\text{CC}}$ | <u>[4]</u> | -   | 10    | -   | -      | -         | -        | -         | pF   |
| 74AHCT                      | 2G126-Q100                          |  |            |     |       |     |        |           |          |           |      |
| t <sub>pd</sub>             | propagation                         | nA to nY; see Figure 5   | <u>[1]</u> |     |       |     |        |           |          |           |      |
|                             | delay                               | $V_{CC} = 4.5 \text{ V} \text{ to } 5.5 \text{ V}$   | [3]        |     |       |     |        |           |          |           |      |
|                             | C <sub>L</sub> = 15 pF              |  | -          | 3.4 | 5.5   | 1.0 | 6.5    | 1.0       | 7.0      | ns        |      |
|                             |                                     | C <sub>L</sub> = 50 pF   |            | -   | 4.8   | 7.5 | 1.0    | 8.5       | 1.0      | 9.5       | ns   |
| t <sub>en</sub> enable time |                                     | nOE to nY; see Figure 6  | <u>[1]</u> |     |       |     |        |           |          |           |      |
|                             |                                     | $V_{CC}$ = 4.5 V to 5.5 V  | [3]        |     |       |     |        |           |          |           |      |
|                             |                                     | C <sub>L</sub> = 15 pF   |            | -   | 3.9   | 5.1 | 1.0    | 6.0       | 1.0      | 6.5       | ns   |
|                             |                                     | C <sub>L</sub> = 50 pF   |            | -   | 5.1   | 7.5 | 1.0    | 9.0       | 1.0      | 9.5       | ns   |
| t <sub>dis</sub>            | disable time                        | nOE to nY; see Figure 6  | [1]        |     |       |     |        |           |          |           |      |
|                             |                                     | $V_{CC} = 4.5 \text{ V} \text{ to } 5.5 \text{ V}$   | [3]        |     |       |     |        |           |          |           |      |
|                             |                                     | C <sub>L</sub> = 15 pF   |            | -   | 4.5   | 6.8 | 1.0    | 8.0       | 1.0      | 8.5       | ns   |
|                             |                                     | C <sub>L</sub> = 50 pF   |            | -   | 6.1   | 8.8 | 1.0    | 10.0      | 1.0      | 11.0      | ns   |
| C <sub>PD</sub>             | power<br>dissipation<br>capacitance | per buffer;<br>$C_L = 50 \text{ pF}; f_i = 1 \text{ MHz};$<br>$V_I = \text{GND to } V_{CC}$        | <u>[4]</u> | -   | 10    | -   | -      | -         | -        | -         | pF   |

## Table 8.Dynamic characteristics ... continuedGND = 0 V; for test circuit see Figure 7.

t<sub>pd</sub> is the same as t<sub>PLH</sub> and t<sub>PHL</sub>.
 t<sub>en</sub> is the same as t<sub>PZL</sub> and t<sub>PZH</sub>.
 t<sub>dis</sub> is the same as t<sub>PLZ</sub> and t<sub>PHZ</sub>.

- [2] Typical values are measured at  $V_{CC}$  = 3.3 V.
- [3] Typical values are measured at V<sub>CC</sub> = 5.0 V.
- [4]  $C_{PD}$  is used to determine the dynamic power dissipation P<sub>D</sub> (µW).
  - $P_{D}$  =  $C_{PD} \times V_{CC}{}^{2} \times f_{i}$  +  $\sum (C_{L} \times V_{CC}{}^{2} \times f_{o})$  where:

 $f_i$  = input frequency in MHz;

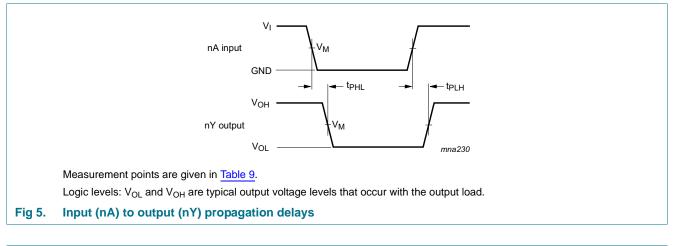
 $f_o = output frequency in MHz;$ 

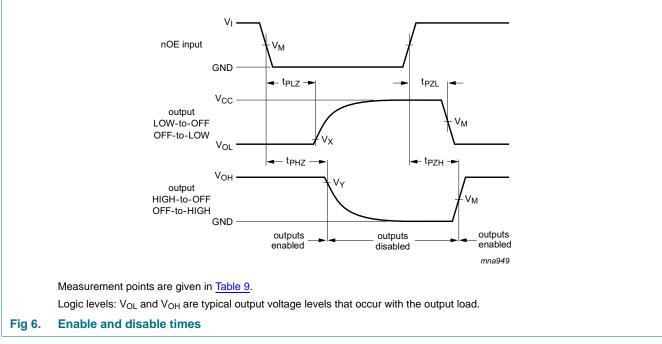
 $C_L$  = output load capacitance in pF;

 $V_{CC}$  = supply voltage in Volt.

Dual buffer/line driver; 3-state

### 12. Waveforms and test circuit

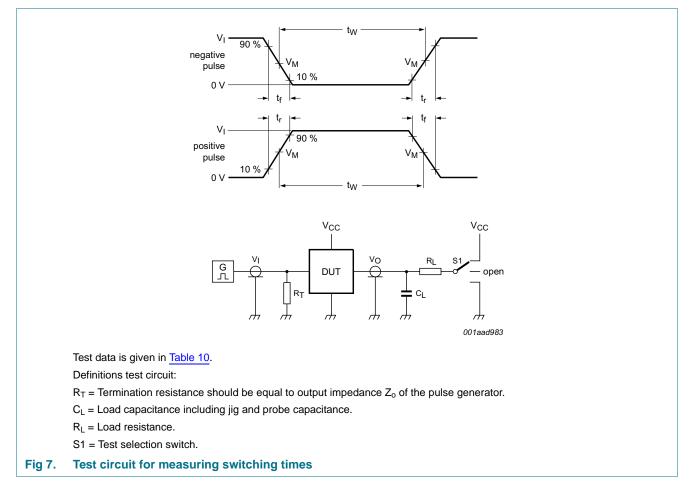




#### Table 9.Measurement points

| Туре             | Input              | Output             |                         |                         |  |  |  |  |
|------------------|--------------------|--------------------|-------------------------|-------------------------|--|--|--|--|
|                  | V <sub>M</sub>     | V <sub>M</sub>     | V <sub>X</sub>          | V <sub>Y</sub>          |  |  |  |  |
| 74AHC2G126-Q100  | 0.5V <sub>CC</sub> | 0.5V <sub>CC</sub> | V <sub>OL</sub> + 0.3 V | V <sub>OH</sub> – 0.3 V |  |  |  |  |
| 74AHCT2G126-Q100 | 1.5 V              | 0.5V <sub>CC</sub> | V <sub>OL</sub> + 0.3 V | V <sub>OH</sub> – 0.3 V |  |  |  |  |

### Dual buffer/line driver; 3-state



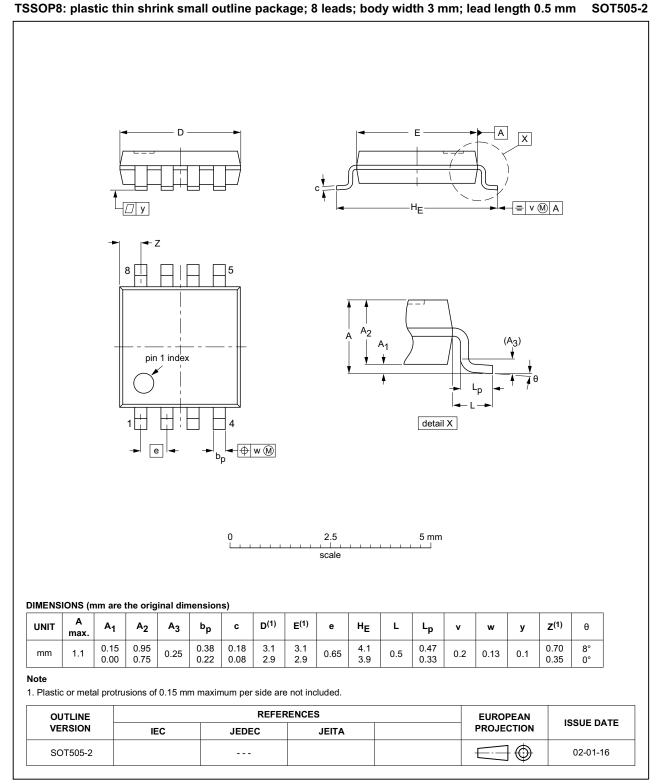
#### Table 10. Test data

| Туре             | Input           |                                 | Load         |      | S1 position                         |                                     |                                     |  |
|------------------|-----------------|---------------------------------|--------------|------|-------------------------------------|-------------------------------------|-------------------------------------|--|
|                  | VI              | t <sub>r</sub> , t <sub>f</sub> | CL           | RL   | t <sub>PHL</sub> , t <sub>PLH</sub> | t <sub>PZH</sub> , t <sub>PHZ</sub> | t <sub>PZL</sub> , t <sub>PLZ</sub> |  |
| 74AHC2G126-Q100  | V <sub>CC</sub> | ≤ 3 ns                          | 15 pF, 50 pF | 1 kΩ | open                                | GND                                 | V <sub>CC</sub>                     |  |
| 74AHCT2G126-Q100 | 3 V             | ≤ 3 ns                          | 15 pF, 50 pF | 1 kΩ | open                                | GND                                 | V <sub>CC</sub>                     |  |

## NXP Semiconductors 74AHC2G126-Q100; 74AHCT2G126-Q100

Dual buffer/line driver; 3-state

### 13. Package outline

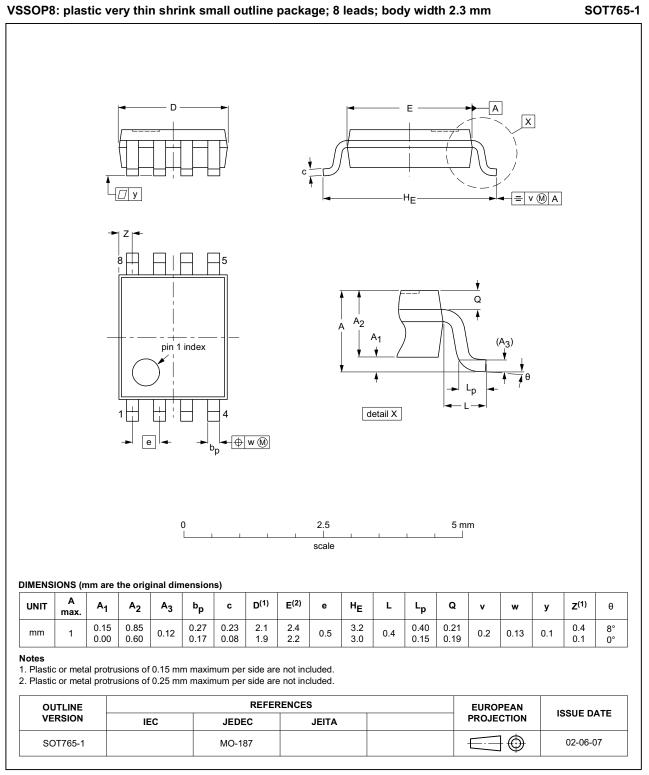


#### Package outline SOT505-2 (TSSOP8) Fig 8.

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## NXP Semiconductors 74AHC2G126-Q100; 74AHCT2G126-Q100

Dual buffer/line driver; 3-state



#### Package outline SOT765-1 (VSSOP8) Fig 9.

74AHC\_AHCT2G126\_Q100 **Product data sheet** 

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Dual buffer/line driver; 3-state

## 14. Abbreviations

| Table 11. Abbreviations |   |  |
|-------------------------|---|--|
| Acronym                 | Description                             |  |
| CMOS                    | Complementary Metal Oxide Semiconductor |  |
| CDM                     | Charged Device Model                    |  |
| DUT                     | Device Under Test                       |  |
| ESD                     | ElectroStatic Discharge                 |  |
| НВМ                     | Human Body Model                        |  |
| MIL                     | Military                                |  |
| MM                      | Machine Model                           |  |
| TTL                     | Transistor-Transistor Logic             |  |

## 15. Revision history

#### Table 12. Revision history

| Document ID              | Release date | Data sheet status  | Change notice | Supersedes |
|--------------------------|--------------|--------------------|---------------|------------|
| 74AHC_AHCT2G126_Q100 v.1 | 20140311     | Product data sheet | -             | -          |

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| Document status[1][2]          | Product status <sup>[3]</sup> | Definition  |
|--------------------------------|-------------------------------|---|
| Objective [short] data sheet   | Development                   | This document contains data from the objective specification for product development. |
| Preliminary [short] data sheet | Qualification                 | This document contains data from the preliminary specification.                       |
| Product [short] data sheet     | Production                    | This document contains the product specification.                                     |

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

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14 of 15

Dual buffer/line driver; 3-state

### **18. Contents**

| 1    | General description 1              |
|------|------------------------------------|
| 2    | Features and benefits 1            |
| 3    | Ordering information 2             |
| 4    | Marking 2                          |
| 5    | Functional diagram 2               |
| 6    | Pinning information 3              |
| 6.1  | Pinning 3                          |
| 6.2  | Pin description 3                  |
| 7    | Functional description 3           |
| 8    | Limiting values 4                  |
| 9    | Recommended operating conditions 4 |
| 10   | Static characteristics 5           |
| 11   | Dynamic characteristics 6          |
| 12   | Waveforms and test circuit         |
| 13   | Package outline 10                 |
| 14   | Abbreviations 12                   |
| 15   | Revision history 12                |
| 16   | Legal information 13               |
| 16.1 | Data sheet status 13               |
| 16.2 | Definitions                        |
| 16.3 | Disclaimers 13                     |
| 16.4 | Trademarks 14                      |
| 17   | Contact information 14             |
| 18   | Contents 15                        |

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